

APPLICATION DATA SHEET**Inventor Information**

Inventor One Given Name : Guy F.
Family Name : Hudson
Postal Address Line One : 1860 South Canonero Way
City : Boise
State or Province : Idaho
County : Ada
Postal or Zip Code : 83709
City of Residence : Boise
State or Prov. Of Residence : Idaho
Country of Residence : USA
Citizenship Country : USA

Correspondence Information

Name Line One : Mark W. Roberts, Ph.D.
Address Line One : DORSEY & WHITNEY LLP
Address Line Two : 1420 Fifth Avenue, Suite 3400
City : Seattle
State or Province : Washington
Postal or Zip Code : 98101
Telephone : 206-903-8800
Facsimile : 206-903-8820
E-Mail : patentseattle@dorseyllaw.com

Application Information

Title : METHODS FOR USING BI-MODAL ABRASIVE
SLURRIES FOR MECHANICAL AND CHEMICAL-
MECHANICAL PLANARIZATION OF
MICROELECTRONIC-DEVICE SUBSTRATE
ASSEMBLIES
Total Drawing Sheets : 5
Formal Drawings : YES
Application Type : Utility
Attorney Docket Number : 500155.05
Assigned : Yes (Large Entity)

Representative Information

Representative Customer No. : 27,076

Continuity Information

This application is a : divisional of

>Application One : 10/155,203
Filing Date : May 23, 2002
which is a : continuation of
>>Application Two : 09/289,790
Filing Date : April 9, 1999
Patent Number : 6,407,000

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